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Team Nexperia

Product data sheet

1. Product profile

1.1 General description

The IP4220CZ6 is designed to protect I/O lines sensitive to capacitive load, such as USB 2.0, ethernet, Digital Video Interface (DVI) and so on, from damage due to ElectroStatic Discharge (ESD). It incorporates four pairs of ultra low capacitance rail-to-rail ESD protection diodes plus a Zener diode to provide protection to signal and supply components from ESD voltages up to ± 8 kV contact discharge. Protection is supply voltage independent due to the rail-to-rail diodes being connected to the Zener diode. The device is encapsulated in a small 6-lead SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- ESD protection up to ±8 kV contact discharge; IEC 61000-4-2, level 4 compliant
- Four pairs of ultra low input capacitance (C_I = 1 pF) ESD rail-to-rail protection diodes
- Low voltage clamping due to integrated Zener diode
- Small 6-lead TSOP6 (SOT457) SMD package

1.3 Applications

- General-purpose downstream ESD protection for high-frequency analog signal ports and high-speed serial data transmission ports in:
 - ◆ Cellular phone and Personal Communication System (PCS) mobile handsets
 - ◆ PC/notebook USB 2.0/IEEE1394 ports
 - **A** DV
 - Cordless telephones
 - Wireless data (WAN/LAN) systems
 - Mobile Internet Devices (MID)
 - Portable media Players (PMP)
 - High-Definition Multimedia Interface (HDMI)



Dual USB 2.0 integrated ESD protection

2. Pinning information

Table 1. Pinning

idbic ii	g			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I/O 1	ESD protection		
2	GND	ground	<u> </u>	6 5 4
3	I/O 2	ESD protection	0	
4	I/O 3	ESD protection	1 2 3	
5	V_P	supply voltage		
6	I/O 4	ESD protection		
				018aaa142

3. Ordering information

Table 2. Ordering information

Type number	Package	Package			
	Name	Description	Version		
IP4220CZ6	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457		

4. Marking

Table 3. Marking codes

Type number	Marking code
IP4220CZ6	20

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{I}	input voltage		0	5.5	V
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4, contact; all pins	-8	+8	kV
T _{stg}	storage temperature		-55	+125	°C

6. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T_{amb}	ambient temperature		-40	-	+85	°C

IP4220CZ6

Dual USB 2.0 integrated ESD protection

7. Characteristics

Table 6. Characteristics

T_{amb} = 25 °C; unless otherwise specified.

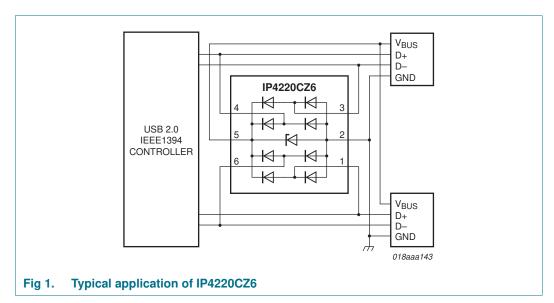
and	, , , , , , , , , , , , , , , , , , ,					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$C_{\text{(I/O-GND)}}$	input/output to ground capacitance	$V_I = 0 V$; $f = 1 MHz$; $V_P = 3 V$	[1] -	1.0	-	pF
$C_{(zd\text{-}GND)}$	Zener diode to ground capacitance	$V_I = 0 V$; $f = 1 MHz$; $V_P = 3 V$	[3] _	40	-	pF
I _{RM}	reverse leakage current	$V_I = 3 V$	[2] _	-	100	nA
V_{BRzd}	Zener diode breakdown voltage	I = 1 mA	<u>[3]</u> 6	-	9	V
V_{F}	forward voltage		-	0.7	-	V

^[1] Pins 1, 3, 4 and 6.

8. Application information

8.1 Universal serial bus 2.0 protection

The device is optimized to protect, for example, two USB 2.0 ports from ESD. Each device can protect both USB data lines and the V_{BUS} supply line. A typical application is shown in Figure 1.



^[2] Pins 1, 3, 4 and 6 to ground.

^[3] Pin 5 to pin 2.

Dual USB 2.0 integrated ESD protection

9. Package outline

Plastic surface-mounted package (TSOP6); 6 leads

ı	DIMENSIONS (mm are the original dimensions)													
	UNIT	A	A ₁	bp	С	D	E	е	HE	Lp	Q	v	w	у
	mm	1.1 0.9	0.1 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT457			SC-74			-05-11-07- 06-03-16	

Fig 2. Package outline SOT457 (SC-74)

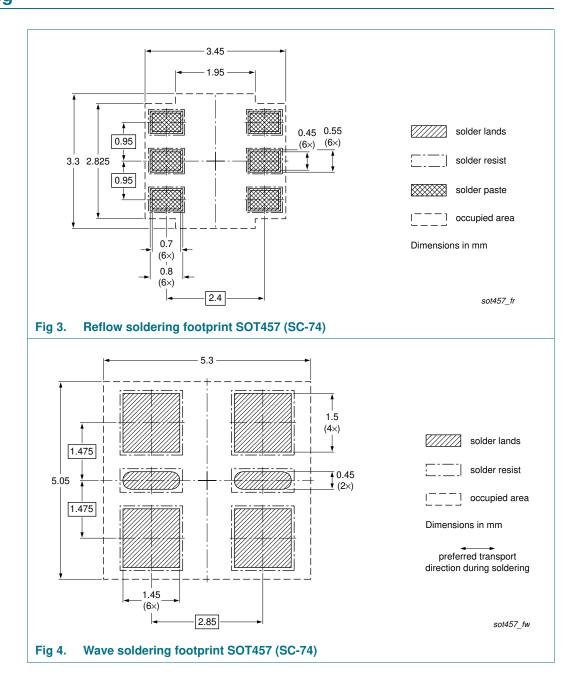
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SOT457

Dual USB 2.0 integrated ESD protection

10. Soldering



Dual USB 2.0 integrated ESD protection

11. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes					
IP4220CZ6 v.5	20110708	Product data sheet	-	IP4220CZ6 v.4					
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 								
	 Legal texts 	have been adapted to the n	ew company name wh	ere appropriate.					
	Section 1 "Product profile": updated								
	Section 2 "Pinning information": updated								
	 Section 4 "I 								
	 Table 4 and 6: parameters V_{I/O}; V_{esd}; C_{I/O(n)}; V_{I/O(n)}; I_{L(n)}; C_{d(Zener)} and V_{BR(Zener)} redefined respectively to V_I; V_{ESD}; C_(I/O-GND); V_I; I_{RM}; C_(zd-GND) and V_{BRzd}. 								
	• Figure 1: updated								
	• Figure 2 "Package outline SOT457 (SC-74)": updated								
	 Section 8.2. IP4220CZ6 spice model: deleted 								
	Section 10 "Soldering": added								
	Abbreviation table: deleted								
	Section 12 "Legal information": updated								
IP4220CZ6 v.4	20050912	Product data sheet	-	IP4220CZ6 v.3					
IP4220CZ6 v.3	20050712	Product data sheet	-	IP4220CZ6 v.2					
IP4220CZ6 v.2	20050608	Product data sheet	-	IP4220CZ6_N v.1					
IP4220CZ6_N v.1	20040917	Preliminary specification	on -	-					

Dual USB 2.0 integrated ESD protection

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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IP4220CZ6

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Dual USB 2.0 integrated ESD protection

14. Contents

1	Product profile	1
1.1	General description	1
1.2	Features and benefits	1
1.3	Applications	1
2	Pinning information	2
3	Ordering information	2
4	Marking	2
5	Limiting values	2
6	Recommended operating conditions	2
7	Characteristics	3
8	Application information	3
8.1	Universal serial bus 2.0 protection	3
9	Package outline	4
10	Soldering	5
11	Revision history	6
12	Legal information	7
12.1	Data sheet status	7
12.2	Definitions	7
12.3	Disclaimers	7
12.4	Trademarks	8
13	Contact information	8
14	Contents	c

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